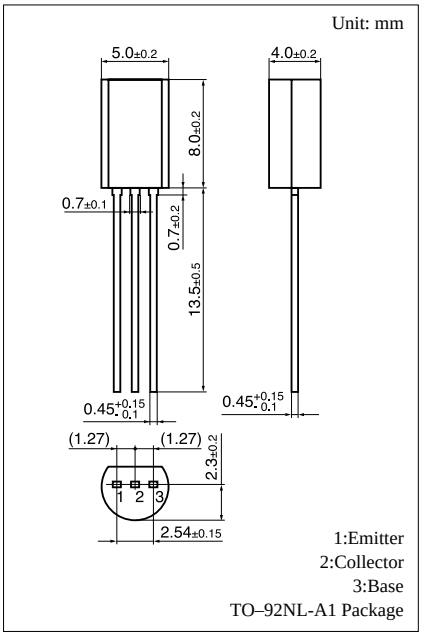
2SC4208, 2SC4208A

Silicon NPN epitaxial planer type

For low-frequency output amplification and driver amplification
Complementary to 2SA1619 and 2SA1619A



Features

- Low collector to emitter saturation voltage $V_{CE(sat)}$.
- Output of 1W is obtained with a complementary pair with 2SA1619 and 2SA1619A.
- Allowing supply with the radial taping.

Absolute Maximum Ratings (Ta=25˚C)

Parameter		Symbol	Ratings	Unit
Collector to base voltage	2SC4208	V_{CBO}	30	V
	2SC4208A		60	
Collector to emitter voltage	2SC4208	V_{CEO}	25	V
	2SC4208A		50	
Emitter to base voltage		V_{EBO}	7	V
Peak collector current		I_{CP}	1	A
Collector current		I_C	500	mA
Collector power dissipation		P_C	1	W
Junction temperature		T_j	150	˚C
Storage temperature		T_{stg}	–55 ~ +150	˚C

Electrical Characteristics (Ta=25˚C)

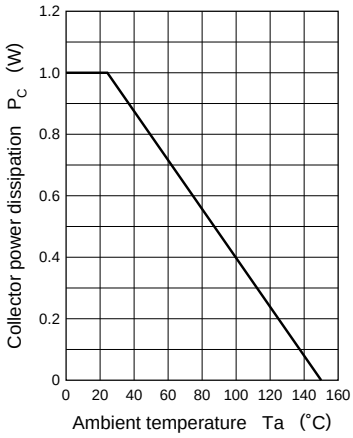
Parameter		Symbol	Conditions	min	typ	max	Unit
Collector cutoff current		I_{CBO}	V_{CB} = 20V, I_E = 0			0.1	µA
Collector to base voltage	2SC4208	V_{CBO}	I_C = 10µA, I_E = 0	30			V
	2SC4208A			60			
Collector to emitter voltage	2SC4208	V_{CEO}	I_C = 10mA, I_B = 0	25			V
	2SC4208A			50			
Emitter to base voltage		V_{EBO}	I_E = 10µA, I_C = 0	7			V
Forward current transfer ratio		h_{FE1} *1	V_{CE} = 10V, I_C = 150mA*2	85		340	
		h_{FE2}	V_{CE} = 10V, I_B = 500mA*2	40			
Collector to emitter saturation voltage		$V_{CE(sat)}$	I_C = 300mA, I_B = 30mA		0.35	0.6	V
Base to emitter saturation voltage		$V_{BE(sat)}$	I_C = 300mA, I_B = 30mA		1.1	1.5	V
Transition frequency		f_T	V_{CB} = 10V, I_E = –50mA, f = 200MHz		150		MHz
Collector output capacitance		C_{ob}	V_{CB} = 10V, I_E = 0, f = 1MHz		6	15	pF

*2 Pulse measurement

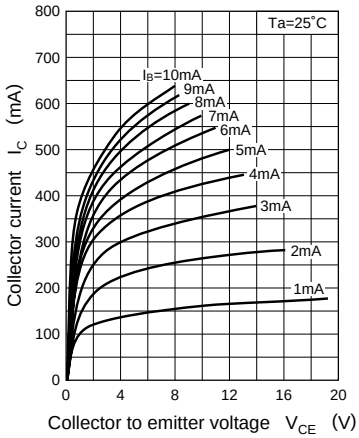
*1h_{FE1} Rank classification

Rank	Q	R	S
h_{FE1}	85 ~ 170	120 ~ 240	170 ~ 340

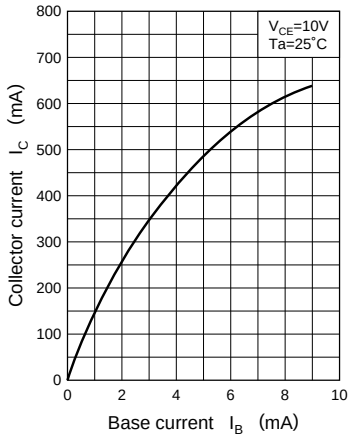
P_C — Ta



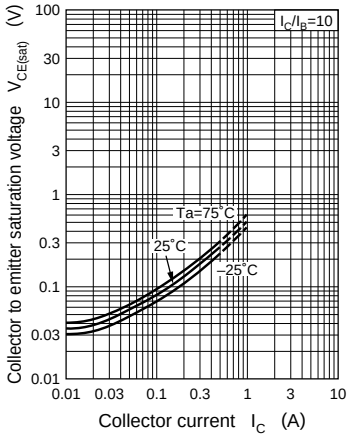
I_C — V_{CE}



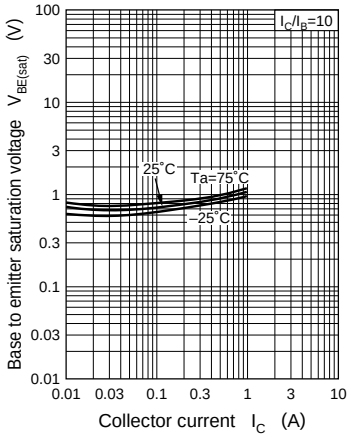
I_C — I_B



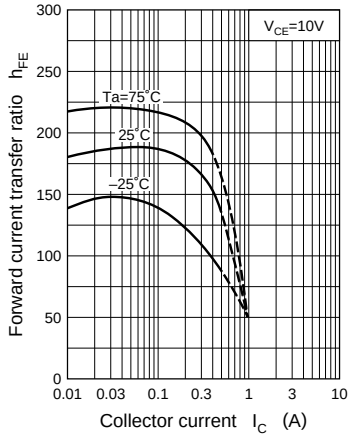
$V_{CE(sat)}$ — I_C



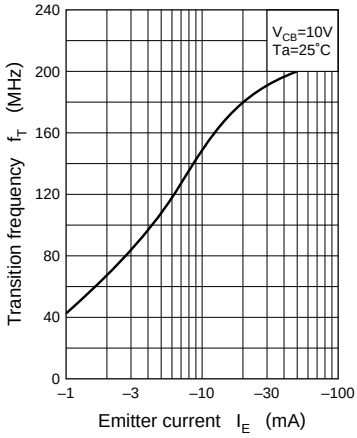
$V_{BE(sat)}$ — I_C



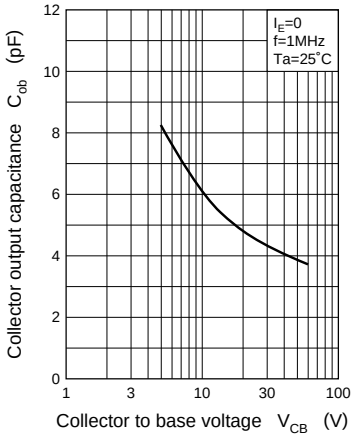
h_{FE} — I_C



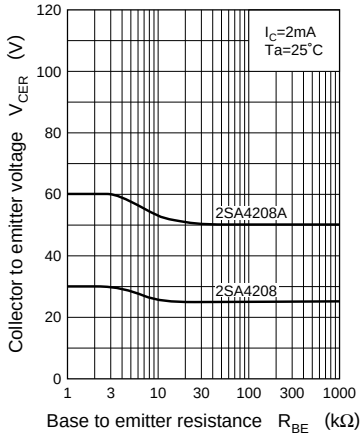
f_T — I_E



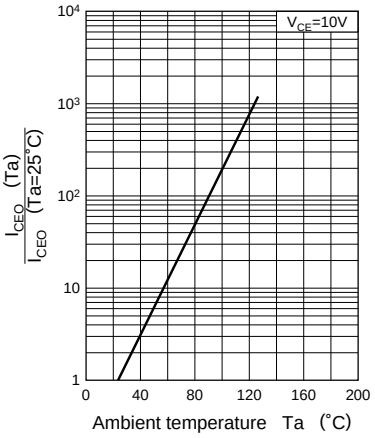
C_{ob} — V_{CB}



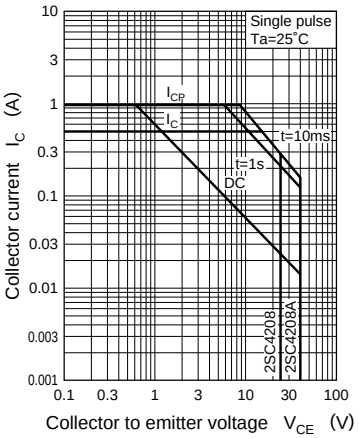
V_{CER} — R_{BE}



I_{CEO} — Ta



Area of safe operation (ASO)



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